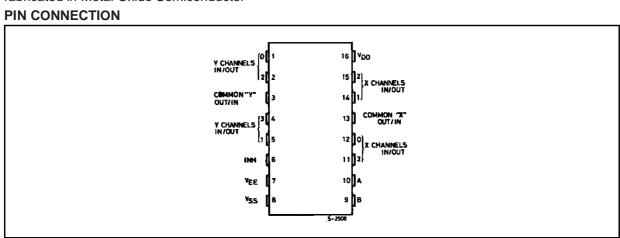


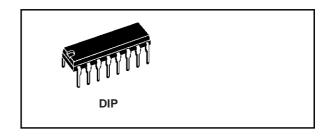
# DIFFERENT 4-CHANNEL ANALOG MULTIPLEXER

- LOW "ON" RESISTANCE : 125Ω (Typ.) OVER 15V p.p SIGNAL-INPUT RANGE FOR V<sub>DD</sub> - V<sub>EE</sub> = 15V
- HIGH "OFF" RESISTANCE : CHANNEL LEAKAGE ± 100pA (Typ.) at V<sub>DD</sub> V<sub>EE</sub> = 18V
- BINARY ADDRESS DECODING ON CHIP
- HIGH DEGREE OF LINEARITY : < 0.5% DISTORTION TYP. at  $f_{IS}$  = 1KHz,  $V_{IS}$  = 5  $V_{pp}$ ,  $V_{DD}$  -  $V_{SS}$  ≥ 10V, RL = 10K $\Omega$
- VERY LOW QUIESCENT POWER DISSIPATION UNDER ALL DIGITAL CONTROL INPUT AND SUPPLY CONDITIONS: 0.2 µW (Typ.) at V<sub>DD</sub> V<sub>SS</sub> = V<sub>DD</sub> V<sub>EE</sub> = 10V
- MATCHED SWITCH CHARACTERISTICS :  $R_{ON} = 5Ω$  (Typ.) FOR  $V_{DD} V_{EE} = 15V$
- WIDE RANGE OF DIGITAL AND ANALOG SIGNAL LEVELS: DIGITAL 3 to 20, ANALOG TO 20V p.p.
- QUIESCENT CURRENT SPECIF. UP TO 20V
- 5V. 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT I<sub>I</sub> = 100nA (MAX) AT V<sub>DD</sub> = 18V T<sub>A</sub> = 25°C
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B " STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"

#### **DESCRIPTION**

The CC4052 is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor





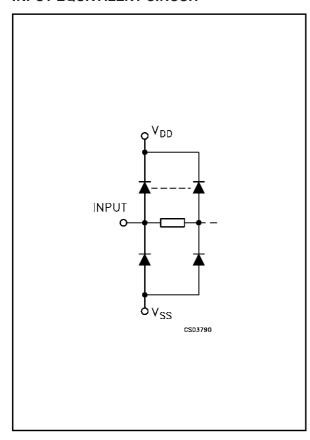
#### **ORDER CODES**

PACKAGE	TUBE	T & R
DIP	CC4052	

technology available in DIP and SOP packages. The CC4052 analog multiplexer/demultiplexer is a digitally controlled analog switch having low ON impedance and very low OFF leakage current. This multiplexer circuit dissipate extremely low quiescent power over the full  $\rm V_{DD}$ -  $\rm V_{SS}$  and  $\rm V_{DD}$ -  $\rm V_{EE}$  supply voltage range, independent of the logic state of the control signals.

When a logic "1" is present at the inhibit input terminal all channel are off. This device is a differential 4-channel multiplexer having two binary control inputs, A and B and an inhibit input. The two binary input signals selects 1 of 4 pairs of channels to be turned on and connect the analog inputs to the outputs.

## **INPUT EQUIVALENT CIRCUIT**



#### **PIN DESCRIPTION**

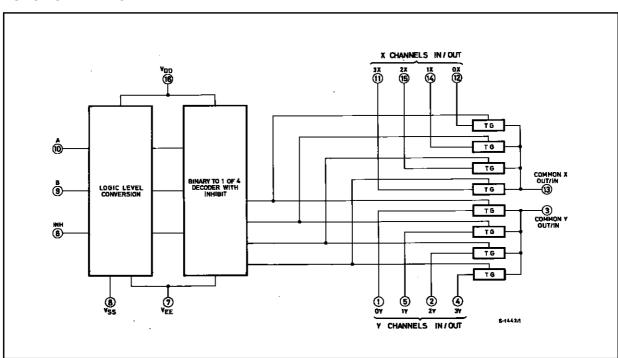
PIN No	SYMBOL	NAME AND FUNCTION
10, 9	A, B	Binary Control Inputs
6	INH	Inhibit Inputs
12, 14, 15, 11	0X to 3X CHANNEL IN/OUT	X channels Input/Output
1, 5, 2, 4	0Y to 3Y CHANNEL IN/OUT	Y channels Input/Output
3	COM Y OUT/ IN	Y Common Output/Input
13	COM X OUT/ IN	X Common Output/Input
7	V <sub>EE</sub>	Supply Voltage
8	$V_{SS}$	Negative Supply Voltage
16	$V_{DD}$	Positive Supply Voltage

## TRUTH TABLE

INHIBIT	В	Α	
0	0	0	0x, 0y
0	0	1	1x, 1y
0	1	0	2x, 2y
0	1	1	3x, 3y
1	Х	Х	NONE

X : Don't Care

## **FUNCTIONAL DIAGRAM**



## **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>DD</sub>	Supply Voltage	-0.5 to +20	V
V <sub>I</sub>	DC Input Voltage	-0.5 to V <sub>DD</sub> + 0.5	V
I <sub>I</sub>	DC Input Current	± 10	mA
$P_{D}$	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T <sub>op</sub>	Operating Temperature	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V<sub>SS</sub> pin voltage.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	3 to 1 8	V
V <sub>I</sub>	Input Voltage	0 to V <sub>DD</sub>	V
T <sub>op</sub>	Operating Temperature	-55 to 125	°C

## **DC SPECIFICATIONS**

	Parameter	Test Condition				Value							
Symbol		V <sub>IS</sub>	V <sub>EE</sub>	V <sub>SS</sub>	V <sub>DD</sub>	T <sub>A</sub> = 25°C		-40 to 85°C		-55 to 125°C		Unit	
		(V)	(V)	(V)	(V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
ΙL	Quiescent Device				5		0.04	5		150		150	
	Current (all				10		0.04	10		300		300	μА
	switches ON or all switches OFF)				15		0.04	20		600		600	μΑ
	,				18		0.08	100		3000		3000	
SWITCH								_					
R <sub>ON</sub>	Resistance	0 <u>&lt;</u> V <sub>1</sub> <u>&lt;</u>			5		470	1050		1200		1200	
		V <sub>DD</sub>	0	0	10		180	400		520		520	Ω
		DD			15		125	280		360		360	
$\Delta_{ON}$	Resistance ∆ <sub>RON</sub>	0 <u>&lt;</u> V <sub>1</sub> <u>&lt;</u>			5		10						
	(between any 2 of 4 switches)	V <sub>DD</sub>	0	0	10		10						Ω
	·			_	15		5						
OFF*	Channel Leakage Current (All Channel OFF) (COMMON O/I)		0	0	18		±0.1	100		1000		1000	nA
OFF*	Channel Leakage Current (Any Channel OFF)		0	0	18		±0.1	100		1000		1000	nA
C <sub>I</sub>	Input Capacitance						5						
Co	Output Capacitance		-5	-5	5		18						pF
C <sub>IO</sub>	Feed through						0.2						
CONTRO	DL (Address or Inhi	bit)		I				•					
$V_{IL}$	Input Low Voltage		Vee =	= V <sub>SS</sub>	5			1.5		1.5		1.5	
				1KΩ	10			3		3		3	V
		= VDD thru		√ <sub>SS</sub>	15			4		4		4	
V <sub>IH</sub>	Input High Voltage	1ΚΩ	I <sub>IS</sub> <	2μΑ	5	3.5			3.5		3.5		
			`	OFF	10	7			7		7		V
			chan	nels)	15	11			11		11		
I <sub>IH,</sub> I <sub>IL</sub>	Input Leakage Current	VI	V <sub>I</sub> = 0/18V		18		±10 <sup>-3</sup>	±0.1		±1		±1	μΑ
C <sub>I</sub>	Input Capacitance						5	7.5					рF
	ad by minimum faasible												

<sup>\*</sup> Determined by minimum feasible leakage measurement for automating testing.

**DYNAMIC ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}C$ ,  $C_{L} = 50 pF$ , all input square wave rise and fall time = 20 ns )

	Test Condition									Value																									
Parameter	V <sub>EE</sub> (V)	<b>R</b> <sub>L</sub> (ΚΩ)	f <sub>I</sub> (KHz)	<b>V</b> <sub>I</sub> (V)	V <sub>SS</sub> (V)	V <sub>DD</sub> (V)		Min.	Тур.	Max.																									
Propagation Delay				V <sub>DD</sub>		5			30	60																									
Time (signal input to		200				10	]		15	30	ns																								
output)						15			11	20																									
Frequency Response Channel "ON" (sine	= V <sub>SS</sub>	1		5(*)		10	V <sub>O</sub> at Common OUT/IN		25		MHz																								
wave input) at 20 log V <sub>O</sub> /V <sub>I</sub> = - 3dB	- * 55	'		3( )		10	V <sub>O</sub> at any channel		60		IVII IZ																								
Feed through (all channels OFF) at 20 log V <sub>O</sub> /V <sub>I</sub> = - 40dB	= V <sub>SS</sub>	1		5(*)		10	V <sub>O</sub> at Common OUT/IN		10		MHz																								
20 log V <sub>0</sub> /V <sub>1</sub> = - 400B	- 33	,		0()		10	V <sub>O</sub> at any channel		8		1411 12																								
Frequency Signal Crosstalk at	= V <sub>SS</sub>	1		5(*)		10	Between Sections (measured on common)		6		MHz																								
Crosstalk at $20 \log V_O/V_I = -40 dB$		- VSS	- VSS	- VSS	- \$55	- \$55	- vss	- \$55	- VSS	- VSS	- VSS	- VSS	- VSS	- VSS	- \$55	- \$55	- \$55	- VSS	- \$55	- \$55	- \$55	- 155	- 135	. 33	- • 55	- • 55	I	3()			10	Between Sections (measured on any channel)		10	
Circ Maus Distantion				2(*)		5			0.3																										
Sine Wave Distortion $f_{IS} = 1KHz$ Sine Wave	$=V_{SS}$	10	1	3(*)		10			0.2		%																								
115 - 11412 0110 11410				5(*)		15	]		0.12																										
CONTROL (Address	or Inhi bi	t)					•																												
Propagation Delay:	0				0	5			360	720																									
Address to Signal	0				0	10	]		160	320																									
OUT (Channels ON or OFF)	0				0	15			120	240	ns																								
0.011)	-5				0	5			225	450																									
Propagation Delay:	0				0	5			360	720																									
Inhibit to Signal OUT	0	1			0	10			160	320	ns																								
(Channel turning ON)	0	'			0	15			120	240	113																								
	-10				0	5	]		200	400																									
Propagation Delay:	0					5			200	450																									
Inhibit to Signal OUT	0	10				10	1		90	210																									
(Channel turning OFF)	0	10				15	1		70	160	ns																								
	-10					5	1		130	300	1																								
Address or Inhibit to Signal Crosstalk	0	10 <sup>(1)</sup>			0	10	$V_C = V_{DD} - V_{SS}$ (square wave)		65		mV peak																								

<sup>(1)</sup> Both ends of channel.

\* Peak to Peak voltage symmetrical about (V<sub>DD</sub> - V<sub>EE</sub> ) /2